Package Dimensions for ESD -, Zener -, Small Signal Switching -, and Schottky Diodes

PACKAGE PAG			
CLP0603-2L		3	
CLP1006-2L		4	
CLP1406-2L		5	
CLP1608-2L		6	
CLP0603-2M	The second secon	7	
CLP1007-5L	To the state of th	8	
DFN1006-2A		9	
<u>DFN1110-3A</u>		10	
LLP1006-2L		11	
<u>LLP1006-2M</u>		12	

PACKAGE PAGE				
<u>LLP1006-3L</u>		13		
LLP1010-5L		14		
<u>LLP1010-6M</u>		15		
LLP1713-7L		16		
<u>LLP1713-9L</u>		17		
LLP2513-13L		18		
LLP3313-17L		19		
LLP75-4L		20		
LLP75-6L		21		
<u>LLP75-7L</u>		22		





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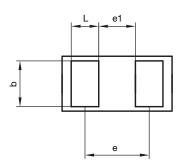
Vishay Semiconductors

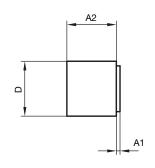
	PAGE	
SOD-123		23
SOD-323		24
SOD-523		25
SOT-23		26
SOT-323		27
<u>SOT-363</u>	War wall	28
SMF (DO-219AB)		29
SMA (DO-214AC)		30
MELF DO-213AB (Plastic)		31
MELF DO-213AB (Glass)		32
MicroMELF		33

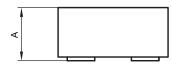
	PAGE	
MicroSMF (DO-219-AC)		34
MiniMELF (SOD-80)	18 18	35
QuadroMELF (SOD-80)		36
DO-35_ (DO-204AH)		37
DO-35_2		37
DO-41 (DO-204AL) (glass)	Test Test	37
SOD-57		38
SOD-64		38

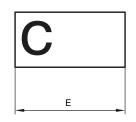


CLP0603-2L PACKAGE DIMENSIONS in millimeters (inches)



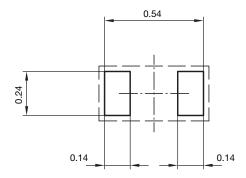






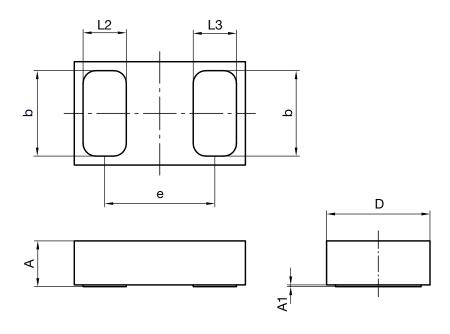
		mm			mils	
	min.	nom.	max.	min.	nom.	max.
Α	0.25	0.28	0.30	9.84	11.02	11.81
A1	0.01	0.01	0.02	0.39	0.39	0.79
A2	0.24	0.27	0.28	9.54	10.63	11.02
b	0.22	0.25	0.28	8.66	9.84	11.02
D	0.27	0.30	0.33	10.62	11.81	12.99
Е	0.57	0.60	0.63	22.44	23.62	24.80
е		0.40			15.75	
e1		0.25	·		9.84	
L	0.12	0.15	0.18	4.72	5.91	7.09

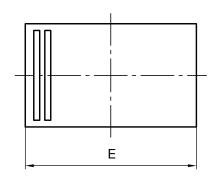
foot print recommendation:



Document no.:S8-V-3906.04-023 (4) Created - Date: 22. Nov. 2010 Rev.9 - Date: 15. Feb. 2017

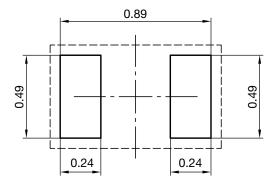
CLP1006-2L PACKAGE DIMENSIONS in millimeters (inches)





	min.	max.	
Α	0.25	0.29	
A1		0.02	
b	0.48	0.53	
D	0.59	0.63	
Е	0.99	1.03	
е	0.65		
L2	0.23 0.28		
L3	0.23 0.28		

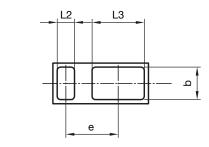
foot print recommendation:



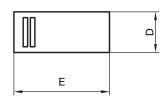
Document no.:S8-V-3906.04-039 (4) Created - Date: 02. April 2015 Rev.2 - Date: 03. Feb. 2016



CLP1406-2L PACKAGE DIMENSIONS in millimeters (inches)

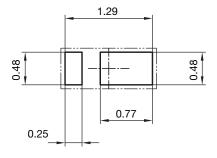






	min.	max.
Α	0.25	0.29
A1		0.02
b	0.46	0.50
D	0.59	0.63
Е	1.39	1.43
е	0.77	
L2	0.23	0.27
L3	0.75	0.79

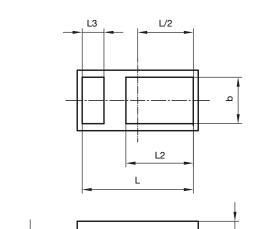
foot print recommendation:



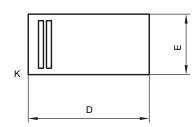
Document no.:S8-V-3906.04-045 (4) Created - Date: 22. Jan. 2016



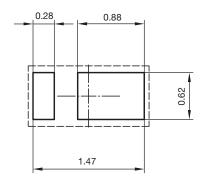
CLP1608-2L PACKAGE DIMENSIONS in millimeters (inches)



		Α	A1	b	D	E	L	L2	L3
mm	min.	0.25		0.58	1.55	0.75	1.42	0.85	0.25
1111111	max.	0.29	0.02	0.65	1.65	0.85	1.52	0.93	0.33



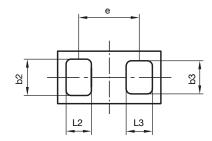
foot print recommendation:

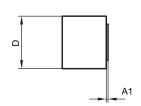


Document no.:S8-V-3906.04-033 (4) Created - Date: 10. Feb. 2014 Rev.4 - Date: 02. July. 2019

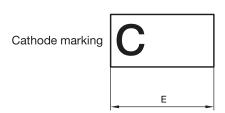


CLP0603-2M PACKAGE DIMENSIONS in millimeters (inches)



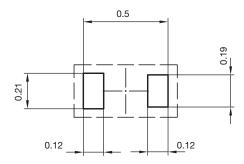






	min.	max.	
Α	0.25	0.29	
A1		0.02	
b2	0.19	0.24	
b3	0.17	0.22	
D	0.29	0.33	
Е	0.59	0.63	
е	0.40		
L2	0.10	0.15	
L3	0.10	0.15	

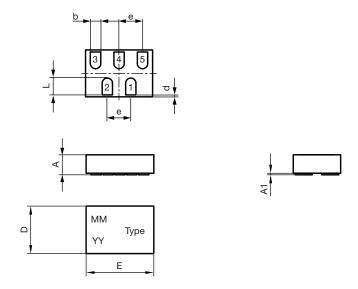
foot print recommendation:



Document no.:S8-V-3906.04-038 (4) Created - Date: 01. April 2015 Rev.3 - Date: 15. Feb. 2017



CLP1007-5L PACKAGE DIMENSIONS in millimeters



	Millimeters		
	min.	max.	
Α	0.25	0.29	
A1	-	0.02	
b	0.13 0.17		
D	0.68 0.73		
E	0.98 1.03		
е	0.35		
L	0.23 0.27		
Radius	0.075		
d	0.03		

foot print recommendation:

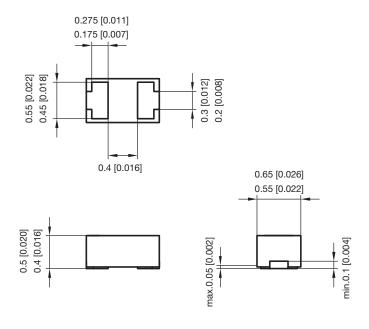
0.35

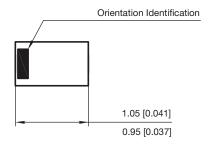
0.35

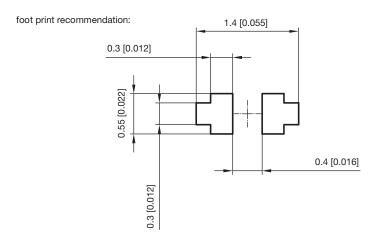
0.855

Document no.: S8-V-3906.04-041 (4) Created - Date: 11-Aug- 2015 Rev. 1 - Date: 30-Jul-2019

DFN1006-2A PACKAGE DIMENSIONS in millimeters (inches)

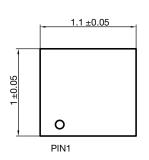


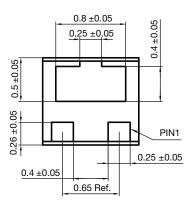


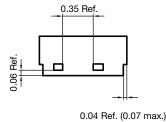


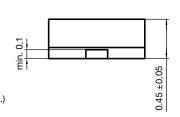
Document no.:S8-V-3906.04-059 (4) Created - Date: 11.July.2018 Rev.1 - Date: 15.January.2019

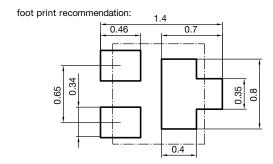
DFN1110-3A PACKAGE DIMENSIONS in millimeters (inches)







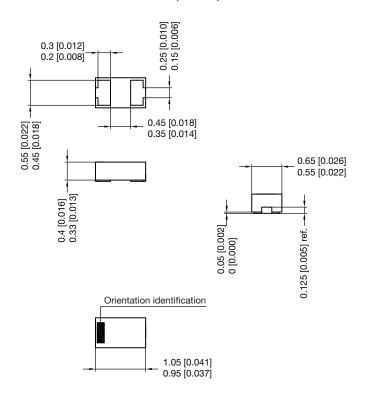




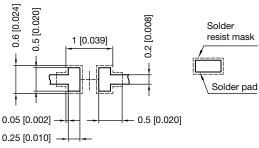
Document no.: S8-V-3906.04-062 (4)
Package name: DFN1110-3A
Created - Date: 04-Apr-2019



LLP1006-2L PACKAGE DIMENSIONS in millimeters (inches)



Foot print recommendation:

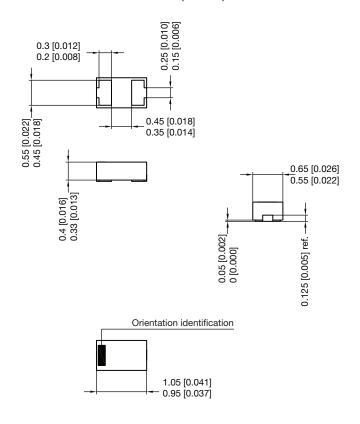


Pad Design Patented: (@US 9.018.537 B2)

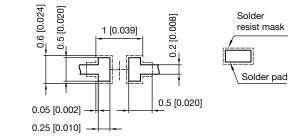
Document no.: S8-V-3906.04-005 (4) Created - Date: 13.July.2007 Rev. 7 - Date: 11.May 2016

20812

LLP1006-2M PACKAGE DIMENSIONS in millimeters (inches)



Foot print recommendation:

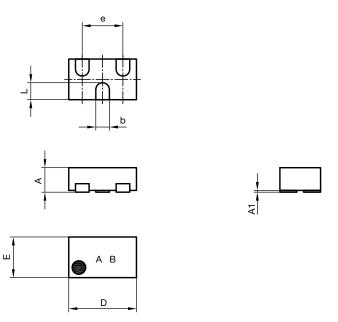


Pad Design Patented: (PUS 9.018.537 B2)

Document no.: S8-V-3906.04-005 (4) Created - Date: 15.Jun 2009 Rev. 7 - Date: 11.May 2016

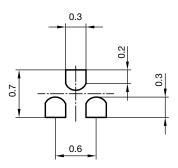
20812

LLP1006-3L PACKAGE DIMENSIONS in millimeters (inches)



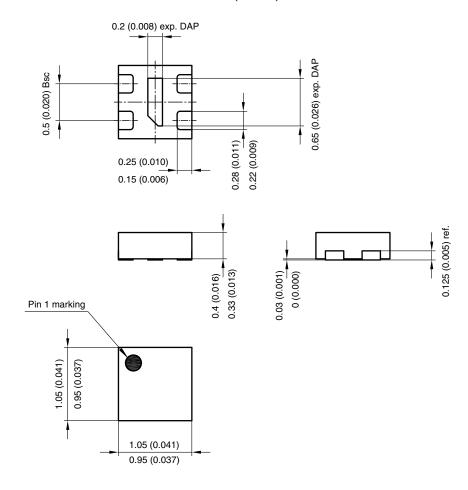
	Millimeters		
	Min.	Max.	
D	0.95	1.05	
E	0.55 0.65		
Α	0.33	0.40	
A1	0 0.05		
b	0.2		
L	0.20 0.30		
е	0.6		

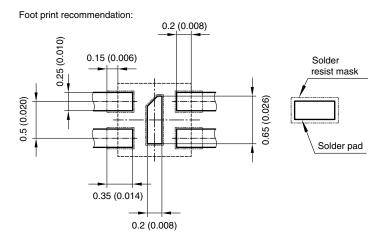
Foot print recommendation:



Document no.:S8-V-3906.04-044 (4) Created - Date: 03. Sep. 2015

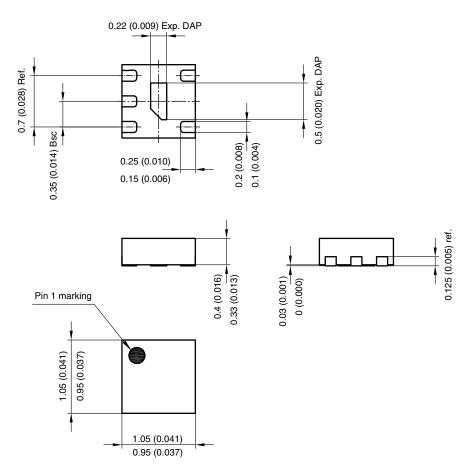
LLP1010-5L PACKAGE DIMENSIONS in millimeters (inches)

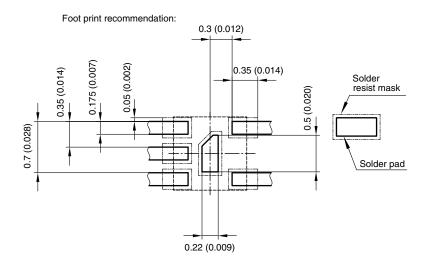




Document no.:S8-V-3906.04-007 (4) Created - Date: 15. April. 2008 Rev. 3 - Date: 11. May. 2016

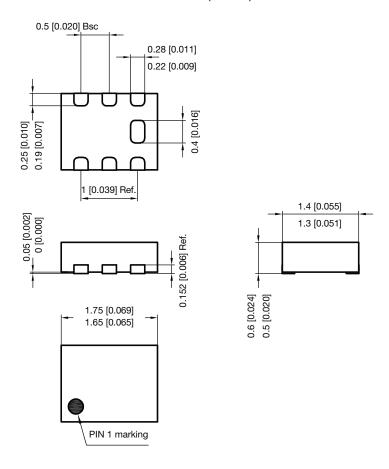
LLP1010-6M PACKAGE DIMENSIONS in millimeters

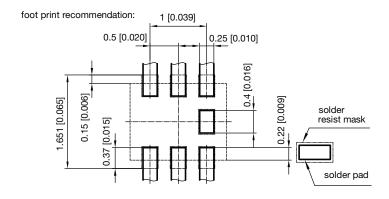




Document no.:S8-V-3906.04-004 (4) Created - Date: 17.July 2007 Rev. 5 - Date: 11.May 2016

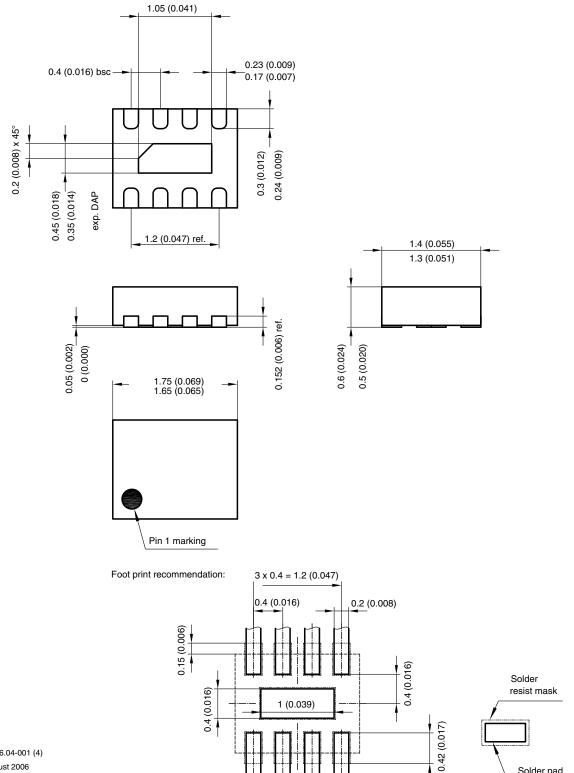
LLP1713-7L PACKAGE DIMENSIONS in millimeters (inches)





Document no.:S8-V-3906.04-008 (4) Created - Date: 15. April 2008 Rev. 3 - Date: 10.Okt.2019

LLP1713-9L PACKAGE DIMENSIONS in millimeters (inches)



Document no.:S8-V-3906.04-001 (4) Created - Date: 28. August 2006 Rev. 1 - Date: 27. May 2008

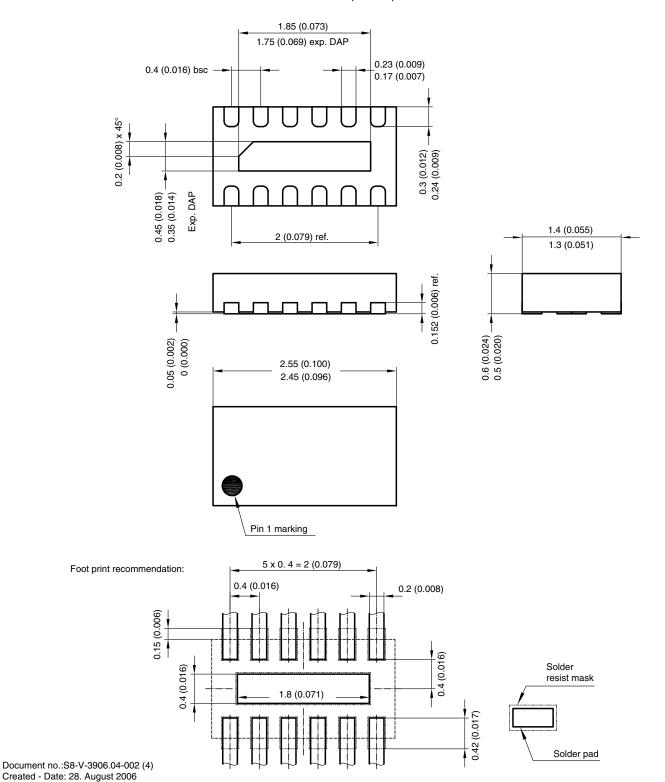
< back

Solder pad

Rev. 1 - Date: 27. May 2008

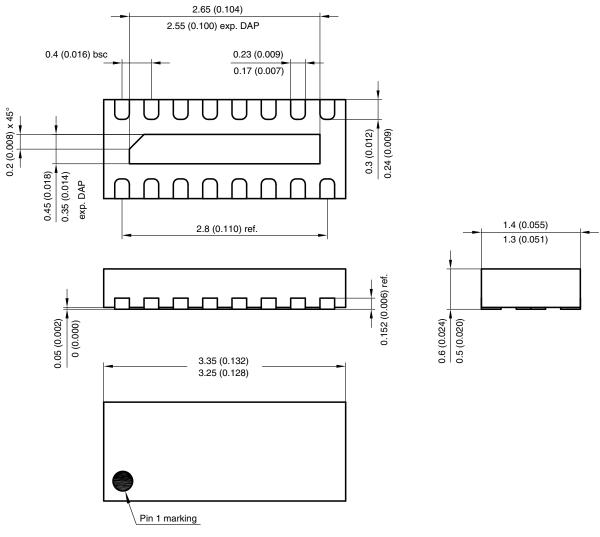
Vishay Semiconductors

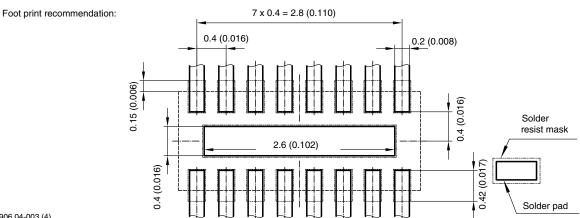
LLP2513-13L PACKAGE DIMENSIONS in millimeters (inches)





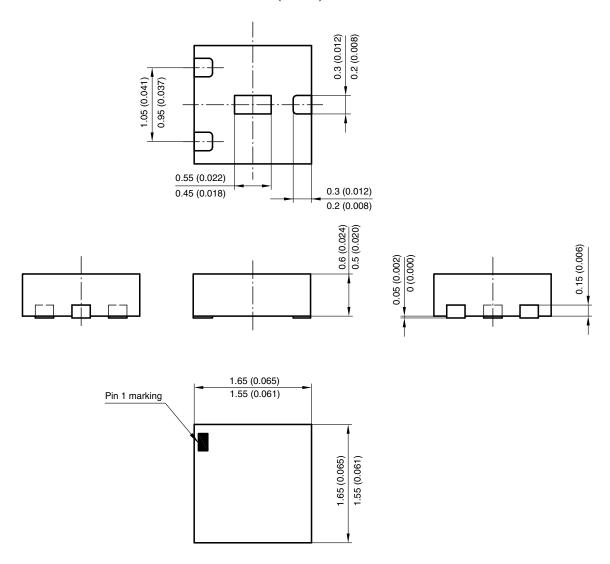
LLP3313-17L PACKAGE DIMENSIONS in millimeters (inches)



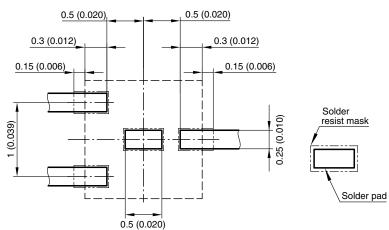


Document no.:S8-V-3906.04-003 (4) Created - Date: 28. August 2006 Rev. 1 - Date: 27. May 2008

LLP75-4L PACKAGE DIMENSIONS in millimeters (inches)

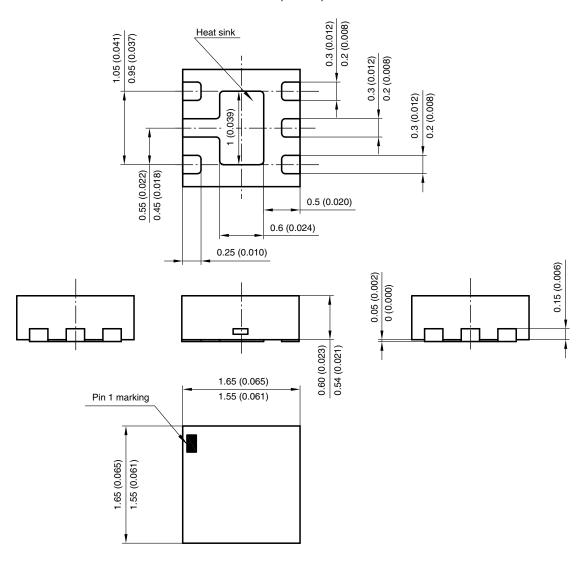


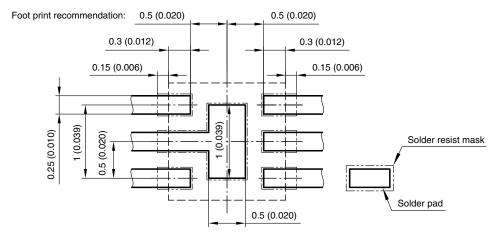
Foot print recommendation:



Document no.:S8-V-3906.02-015 (4) Created - Date: 04. September 2007 Rev. 2 - Date: 09. Sep. 2008

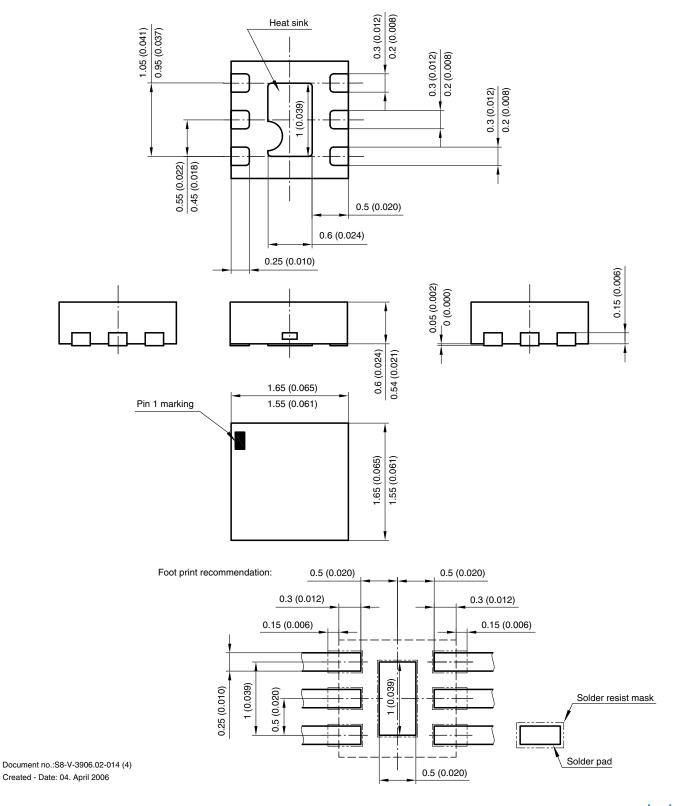
LLP75-6L PACKAGE DIMENSIONS in millimeters (inches)





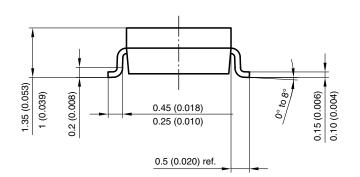
Document no.:S8-V-3906.02-010 (4) Created - Date: 04. May 2005 Rev. 4 - Date: 21. March 2006

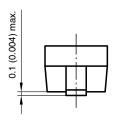
LLP75-7L PACKAGE DIMENSIONS in millimeters (inches)



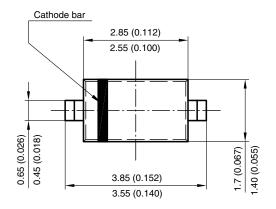


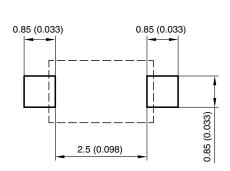
SOD-123 PACKAGE DIMENSIONS in millimeters (inches)





Mounting Pad Layout

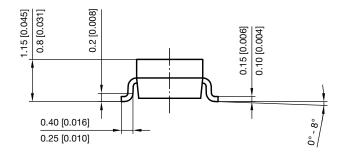


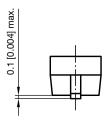


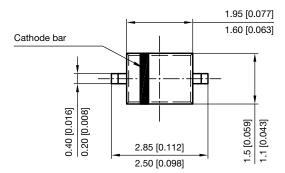
Rev. 4 - Date: 24. Sep. 2009 Document no.: S8-V-3910.01-001 (4)



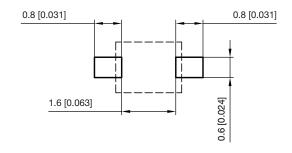
SOD-323 PACKAGE DIMENSIONS in millimeters (inches)







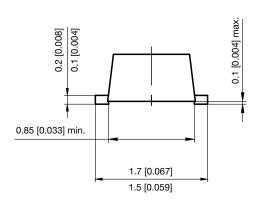
Footprint recommendation:

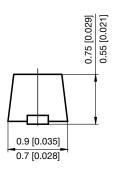


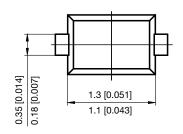
Document no.: S8-V-3910.02-001 (4) Created - Date: 24.August.2004 Rev. 6 - Date: 23.Sept.2016

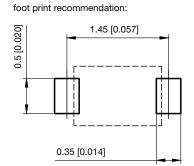


SOD-523 PACKAGE DIMENSIONS in millimeters (inches)









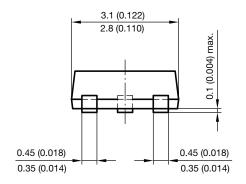
Document no.: S8-V-3880.02-003 (4) Create Date: 04-Apr-2017 Rev. 3 Date: 27-May-2019

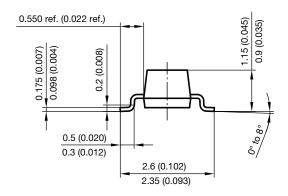


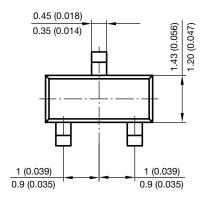
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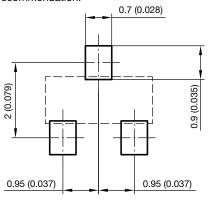
SOT-23 PACKAGE DIMENSIONS in millimeters (inches)





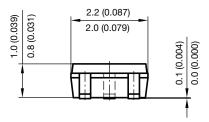


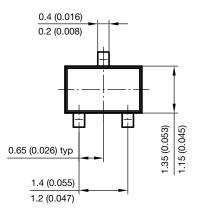
Foot print recommendation:



Document no.: 6.541-5014.01-4 Rev. 8 - Date: 23. Sep. 2009

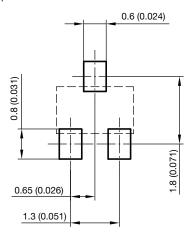
SOT-323 PACKAGE DIMENSIONS in millimeters (inches)





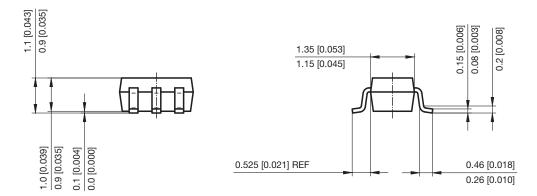
0.46 (0.018) 0.26 (0.010) 0.525 (0.021) ref. 2.45 (0.096) 2.15 (0.085)

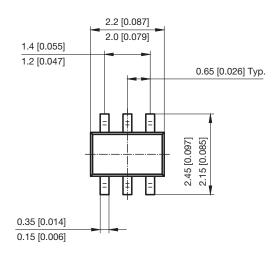
foot print recommendation:

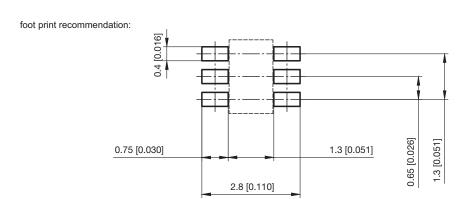


Document no.: 6.541-5040.02-4 Rev. 1 - Date: 06. April 2010

SOT-363 PACKAGE DIMENSIONS in millimeters (inches)

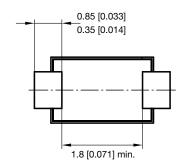


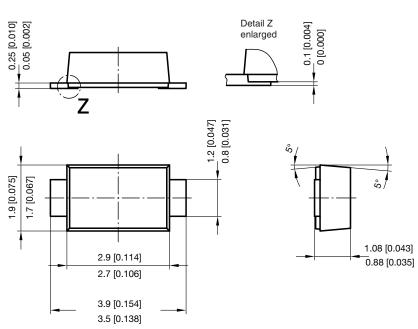




Document no.: S8-V-3855.02-002 (4) Created - Date: 23.June.2017

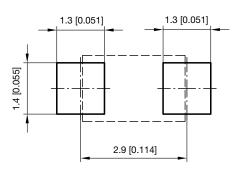
SMF (DO-219AB) PACKAGE DIMENSIONS in millimeters (inches)





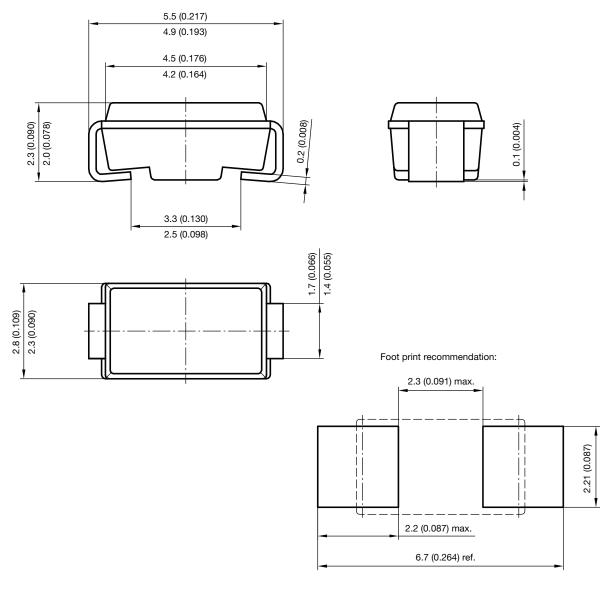
foot print recommendation:

Reflow soldering



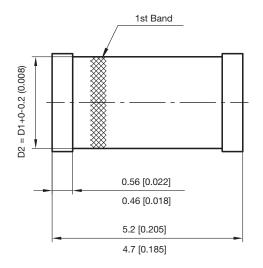
Document no.: S8-V-3915.01-001 (4) Created - Date: 15. February 2005 Rev. 5 - Date: 09. Oct. 2017

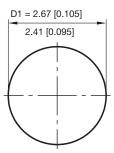
SMA (DO-214AC) PACKAGE DIMENSIONS in millimeters (inches)



Document no.: S8-V-3848.01-003 (4) Created - Date: 18. February 1997 Rev. 8 - Date: 10. November 2006

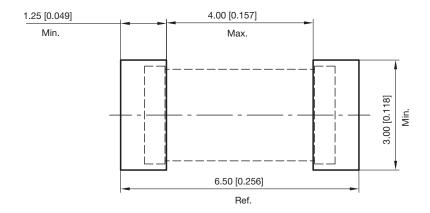
MELF DO-213AB (PLASTIC) PACKAGE DIMENSIONS in millimeters (inches)





1st Band denotes type and positive end (cathode)

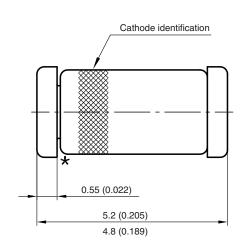
foot print recommendation:

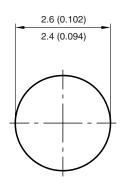


Document no.:S8-V-3453.03-001 (4)

Created - Date: 13.May.2009

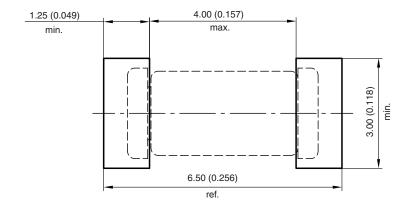
MELF DO-213AB (GLASS) PACKAGE DIMENSIONS in millimeters (inches)





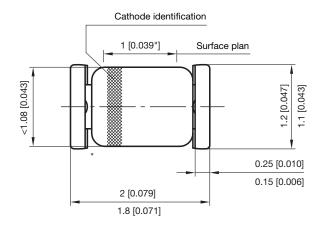
★ The gap between plug and glass can be either on cathode or anode side

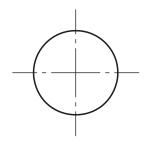
Foot print recommendation:



Document no.:S8-V-3453.02-001 (4) Rev. 3 - Date: 07 June 2006

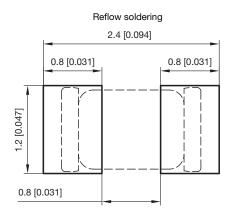
MicroMELF PACKAGE DIMENSIONS in millimeters (inches)

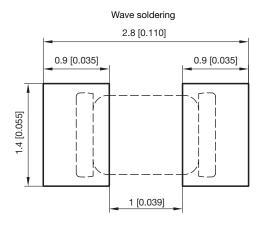




* The gap between plug and glass can be either on cathode or anode side

foot print recommendation:

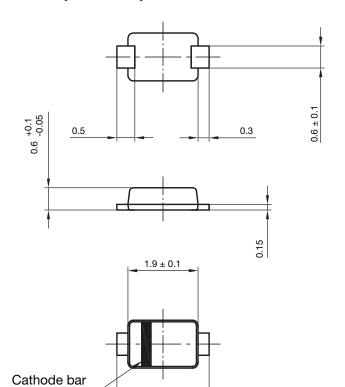




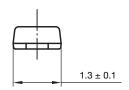
Document no.:6.560-5007.02-4 Created - Date: 23.February.2004 Rev. 02 - Date: 27.February.2007



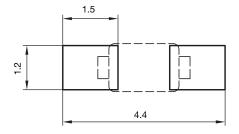
MicroSMF (DO-219AC) PACKAGE DIMENSIONS in millimeters



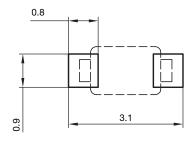
 2.5 ± 0.1



foot print recommendation for wave soldering:

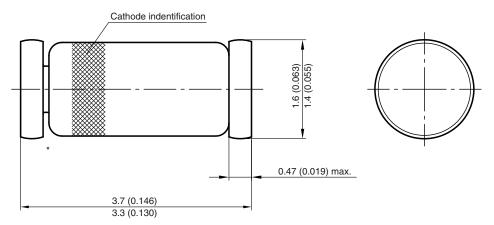


foot print recommendation for reflow soldering:

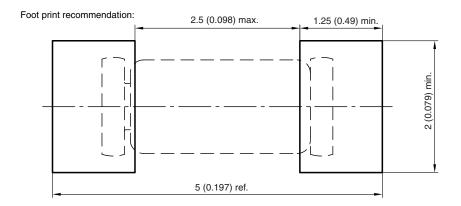


Document no.:S8-V-3910.03-001 (4) Created - Date: 02.Dec.2010 Rev. 5 - Date: 06.May. 2014

MiniMELF (SOD-80) PACKAGE DIMENSIONS in millimeters (inches)

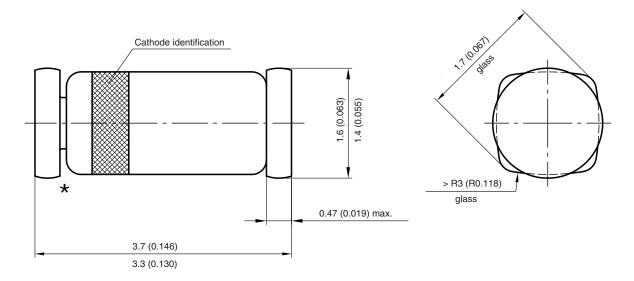


^{*} The gap between plug and glass can be either on cathode or anode side

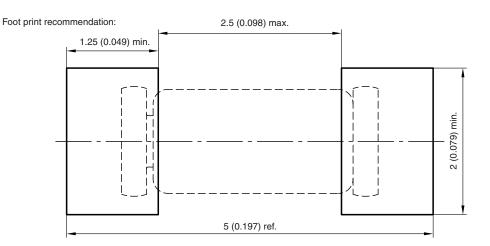


Document no.:6.560-5005.01-4 Rev. 8 - Date: 07.June.2006

QuadroMELF (SOD-80) PACKAGE DIMENSIONS in millimeters (inches)

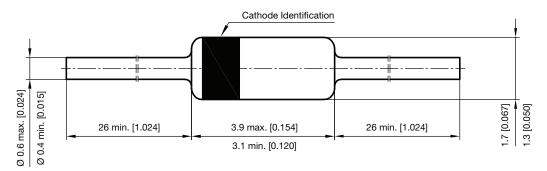


★ The gap between plug and glass can be either on cathode or anode side



Created - Date: 03.November.2003 Rev. 11 - Date: 07.June 2006 Document no.:6.560-5006.01-4

DO-35 (DO-204AH) PACKAGE DIMENSIONS in millimeters (inches)

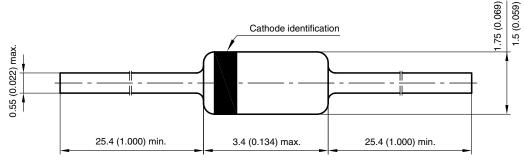


Document no.: SB-V-3906.04-031(4) Rev. 6 - Date: 19. December 2011

< back

DO-35_02 PACKAGE DIMENSIONS in millimeters (inches)

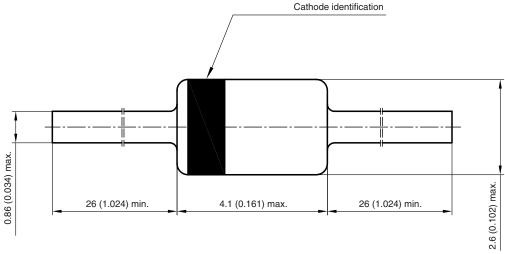
only for 1N4148 from Tak Cheong (non-automotive part)



Document no.: 6.560-5004.12-4 Created - Date: 17. March 2008

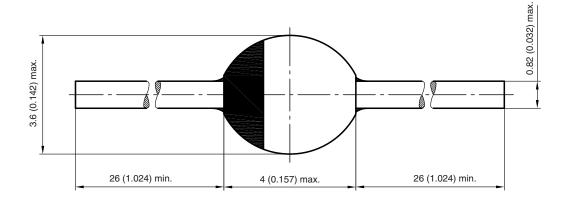
< back

DO-41 (DO-204AL) (GLASS) PACKAGE DIMENSIONS in millimeters (inches)



Document no.: 6.561-5001.02-4 Rev. 3 - Date: 09 - February 2005

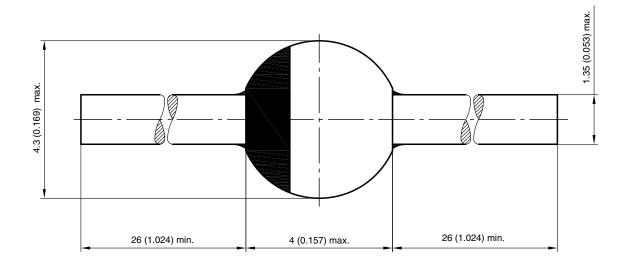
SOD-57 PACKAGE DIMENSIONS in millimeters (inches)



Rev. 3 - Date: 09.February 2005 Document no.:6.563-5006.3-4

< back

SOD-64 PACKAGE DIMENSIONS in millimeters (inches)



Rev. 3 - Date: 09.February 2005 Document no.:6.563-5006.4-4